

PATENT ASSIGNMENT

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 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Ching-Wen Hung</td> <td>03/14/2013</td> </tr> <tr> <td>Chih-Sen Huang</td> <td>03/14/2013</td> </tr> <tr> <td>Po-Chao Tsao</td> <td>03/14/2013</td> </tr> </tbody> </table>		Name	Execution Date	Ching-Wen Hung	03/14/2013	Chih-Sen Huang	03/14/2013	Po-Chao Tsao	03/14/2013
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<table border="1"> <tr> <td>Name:</td> <td>UNITED MICROELECTRONICS CORP.</td> </tr> <tr> <td>Street Address:</td> <td>No.3, Li-Hsin Road 2, Science-Based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Hsin-Chu City</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	UNITED MICROELECTRONICS CORP.	Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	City:	Hsin-Chu City	State/Country:	TAIWAN
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PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13802917</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13802917				
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CORRESPONDENCE DATA									
<p>Fax Number: 7039974517 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 3027291562 Email: Patent.admin.uspto.cr@naipo.com Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506 Address Line 4: Merrifield, VIRGINIA 22116</p>									
ATTORNEY DOCKET NUMBER:	NAUP1608USA								
NAME OF SUBMITTER:	SHELLEY KUO								
<p>Total Attachments: 6 source=1598121#page1.tif source=1598121#page2.tif source=1598121#page3.tif source=1598121#page4.tif source=1598121#page5.tif source=1598121#page6.tif</p>									

CH \$40.00 13802917

**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

Title of Invention:

PLUG STRUCTURE AND PROCESS THEREOF

As the below named inventor, I hereby declare that:
This declaration is directed to:

☒ The attached application, or

☐ United States application number _____ filed on _____, or

☐ PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In consideration of the payment by **UNITED MICROELECTRONICS** having a postal address of **CORP.**

No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.

(referred to as "ASSIGNEE" below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal

representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I have hereunto set hand and seal this MAR 14 2013 (Date of signing)

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.

Docket No NAUP1608USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Ching-Wen Hung

Date: MAR 14 2013

Signature: Ching-Wen Hung

NPO#NAU-P1608-USA:0
CUST#UMCD-2012-0385

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F#NPO-P0002E-US1201
DSC0-101U017820

PATENT
REEL: 029992 FRAME: 0727

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LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Chih-Sen Huang**

Date: **MAR 14 2013**

Signature: Chih-Sen Huang

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CUST#UMCD-2012-0385

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F#NPO-P0002E-US1201
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Inventor: **Po-Chao Tsao**

Date: **MAR 14 2013**

Signature: _____

Po-Chao Tsao

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RECORDED: 03/14/2013

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